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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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a lead-free package

High Performance PureCel[®] Sensor Brings 8-Megapixel Selfies to Mainstream Smartphones

OmniVision's OV8856 is a new 1/4-inch 8 megapixel PureCel sensor designed for front- and rear-facing camera applications in mainstream mobile devices. Built on advanced 1.12-micron pixel architecture, the extremely compact OV8856 offers industry-leading image quality and improved performance when compared with previous-generation 8-megapixel image sensors.

The 1/4-inch OV8856 leverages OmniVision's PureCel pixel architecture to capture full-resolution 8-megapixel images and video at 30 frames per second (fps), and 1080p high-definition (HD) video at 60 fps. The power-efficient OV8856 sensor also supports interlaced high dynamic range (iHDR) for clear images and video in high- and low-light conditions. Using a highspeed four-lane MIPI interface, the OV8856 can output full-resolution, 8-megapixel 30 fps video over two MIPI lanes without requiring any data compression.

The OV8856 is one of the smallest 8-megapixel sensors on the market, and is approximately 15 percent smaller than OmniVision's previous-generation OV8858 image sensor. The OV8856 can fit into a 6.5 mm x 6.5 mm fixed-focus module with a z-height of approximately 4 mm.

Find out more at www.ovt.com.





Applications

Cellular Phones

Tablets

PC Multimedia

Product Features

- 1.12 µm x 1.12 µm pixel
- optical size of 1/4"
- 32.9° CRA for < 5mm Z-height
- programmable controls for frame rate,

supports images sizes: 8MP (4:3, 3264x2448), 8MP (16:9, 3264x1836), EIS 1080p (2112x1188), 1080p (1920x1080), EIS 720p (1408x792), and more

- 8MP at 30 fps (720Mbps/4-lane or 1.44Gbps/2-lane)
- two on-chip phase lock loops (PLLs)
- two-wire serial bus control (SCCB)
- programmable (OTP) memory
- image quality control: defect pixel correction, automatic black level calibration, lens shading correction and alternate row HDR

- OV08856-GA4A
- (color, chip probing, 200 µm backgrinding, reconstructed wafer with good die)

Product Specifications

- active array size: 3264 x 2448
- power supply:
 core: 1.14 1.26V (1.2V nominal)
 analog: 2.6 3.0V (2.8V nominal)
 I/0: 1.7 1.9V (1.8V)
- power requirements:
 active: 150 mW
- standby: 0.8 uW
- XSHUTDN: 1 µW
- temperature range:
 operating: -30°C to +85°C junction
 - temperature - stable image: 0°C to +60°C junction temperature
- output interfaces: up to 4-lane MIPI serial output
- output formats: 10-bit RGB RAW
- lens size: 1/4"
- lens chief ray angle: 32.9° non-linear

- input clock frequency: 6 27 MHz ■ max S/N ratio: 36.5 dB
- dynamic range: 70 dB @ 8x gain
- maximum image transfer rate:
- 3264x2448: 30 fps 3264x1836: 30 fps - 2112x1188: 60 fps - 1920x1080: 60 fps
- 1408x792: 90 fps
- sensitivity: 480 mV/lux-sec
- scan mode: progressive
- pixel size: 1.12 μm x 1.12 μm
- dark current: 12 e⁻/sec @ 60°C junction temperature
- image area: 3678.336 µm x 2767.68 µm
- die dimensions: - COB: 4806 μm x 3969 μm - RW: 4856 μm x 4019 μm

Functional Block Diagram





Version 1.2, September, 2016

OV8856